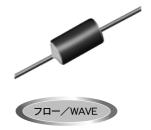
フェライトビーズインダクタ (リードタイプ)

LEADED FERRITE BEADS INDUCTORS

-25~+85℃ OPERATING TEMP



特長 FEATURES

- ・損失分の大きなフェライト材料を使用
- ・基板への実装が容易
- ・用途に合わせた幅広いバリエーション

- · Use of high loss ferrite material.
- · Easy mounting on PC boards.
- · Available in a wide range of values and configurations to suit most applications.

用途 APPLICATIONS

- ・各種デジタル機器におけるデジタル信号の波形整形、データラインの高周 波ノイズ吸収
- · Waveform correction of digital signals from digital equipment and absorption of high-frequency noise from data lines.

形名表記法 ORDERING CODE

形式 FB フェライトビーズインダクタ

形状	
Α	アキシャルリード
R	ラジアルリード

コア寸法 (D 寸法)[mm]		
03	<i>ϕ</i> 2.5	
04	ø3.5	
05	5.0	
06	6.0	
07	7.5	

4

材質コード 材質によりインピー HA ダンス特性が異なる 5

公称インピーダンス[Ω以上]		
例		
850	85	
121	120	
03タイプ除く		

当社管理記号			
-00 標準品			

6

リード加工形状(mm)			
AB	26.0幅ストレートリードつづら折りテービング	SA	2.5ピッチストレートリードテーピング
BB	52.0幅ストレートリードつづら折りテービング	SB	5.0ピッチストレートリードテーピング
KD	10.0ピッチ コの字形フォーミング単品	UB	5.0ピッチラジアルフォーミングテーピング
KE	12.5ピッチ コの字形フォーミング単品	US	5.0ピッチラジアルフォーミング単品
KF	15.0ピッチ コの字形フォーミング単品	VB	5.0ピッチ両リードフォーミングテーピング
NA	2.5ピッチストレートリード単品(FBR)	VS	5.0ピッチ両リードフォーミング単品
	ストレートリード単品(FBA)		
NR	50ピッチリード単品		



Type	
FB	Ferrite Beads



Configuration			
Α	Axial lead		
R	Radial lead		

Core Dimensions[mm]		
03	φ2.5	
04	φ3.5	
05	5.0	
06	6.0	
07	7.5	

Material code		
HA Refer to impeda		Refer to impedance curves
	VA	for material difference

Nominal Impedance			
example			
850	85		
121	120		
Excluding 03Type			

Internal code		
-00	Standard Products	

6				
Le	Lead configuration (mm)			
AB	straight lead (26mm lead space) / ammo	SA	Straight lead (FBR05 type) / ammo	
BB	straight lead (52mm lead space) / ammo	SB	Straight lead (FBR07 type) / ammo	
KD	Formed lead (10mm pitch) / bulk	UB	Radial lead formed / ammo	
KE	Formed lead (12.5mm pitch) / bulk	US	Formed lead (crimped) / bulk	
KF	Formed lead / bulk (15.0mm pitch) / bulk	VB	Dual side lead formed (crimped) / ammo	
NA	straight lead (2.5mm pitch)/bulk (FBR)	VS	Formed lead / bulk	
	straight lead / bulk (FBA)			
NB	Formed lead (crimped) / bulk			



			形 状 Co	onfigurations		Dimensions	s(mm)(inch)
	Туре	テーピング	Taping	単 品	Bulk		
		ストレート Straight	フォーミング Formed	ストレート Straight		D	L
	03HA450□ -00 03VA450□ -00	W:26,52 (1.02, 2.05) P:5.0 (0.197)	UB P:12.7 (0.500)	NA	KD,KE,KF :: F:10,12.5.15 (0.39,0.492,0.591) US F:5.0 (0.197)	2.5±0.2 (0.098±0.008)	4.5±0.3 (0.177±0.012)
FBA	04HA450□ -00 04VA450□ -00	AB,BB W:26,52 (1.02,2.05) P:5.0 (0.197)	VB UB P:12.7 (0.500)	NA 	KD,KE,KF F:10,12.5,15 (0.39,0.492,0.591) VS US F:5.0 (0.197)	3.5±0.2 (0.138±0.008)	4.5±0.3 (0.177±0.012)
	04HA600□ -00 04VA600□ -00	AB, BB W:26,52 (1.02, 2.05) P:5.0 (0.197)	VB P :12.7 (0.500)	NA ———	KD,KE,KF F:10,12.5,15 (0.39,0.492,0.591) VS F:5.0 (0.197)	3.5±0.2 (0.138±0.008)	6.0 ^{+0.5} -0 (0.236 ^{+0.020})
	04HA900□ -00 04VA900□ -00	AB, BB W:26,52 (1.02, 2.05) P:5.0 (0.197)	VB P:12.7 (0.500)	NA	KE,KF F:12.5, 15 (0.492, 0.591)	3.5±0.2 (0.138±0.008)	9.0±0.5 (0.354±0.020)
	05VA121□ -00		SA P P:12.7 (0.500)	_	NA F:2.5 (0.098)	5.0max. (0.197max.)	7.5 (0.295)
FBR	06HA850NA-00 06VA850NA-00 06HA121NA-00 06VA121NA-00				NA F:2.5 (0.098)	6.0±0.5 (0.236±0.020)	5.0 (0.197) 7.0 (0.276)
	07HA850□ -00 07VA850□ -00 07HA121□ -00 07VA121□ -00		S B P:12.7 (0.500)		NB F:5.0 (0.197)	7.5±0.5 (0.295±0.020)	5.5 (0.217) 7.5 (0.295)

形名の \square にはリード加工形状記号が入ります。 \square Please specify the lead configuration code. % リード線径d寸法は、0.65±0.05mm 但し、FBR05,07タイプの ϕ d寸法は0.6±0.05mm

Note: Lead diameter (#d) shall fall within a range of 0.65mm±0.05mm, FBR05, and FBR07 types however , will have a lead diameter (ϕ d) range of 0.6mm \pm 0.05mm.

アイテム一覧 PART NUMBERS

	形 名 Ordering code	インピーダンス Impedance [Ω]min.	, , .	ス測定周波数 equency[MHz] Material	定格 Rated curr 材質	電流 ent[A]max. Material
		[52]11111.	HA	VA	HA	VA
	03△450□-00	35.0	50	100	7.0	7.0
FBA	04△450□-00	45.0	50	100	7.0	7.0
FDA	04△600□-00	60.0	50	100	7.0	7.0
	04△900□-00	90.0	50	100	7.0	7.0
	05VA121 □ -00	120.0		100		7.0
	06△850NA-00	85.0	50	100	7.0	7.0
FBR	06△121NA-00	120.0	50	100	7.0	7.0
	07△850□-00	85.0	50	100	7.0	7.0
	07△121□-00	120.0	50	100	7.0	7.0

形名の△には材質記号(HA,VA)、□にはリード加工形状記号が入ります。

- \triangle Please specify material codes(HA,VA) and \Box lead configuration code.
- ※直流抵抗 DC Resistance:0.01 Ωmax、絶縁抵抗 Insulation resistance:1.0MΩmin

セレクションガイド Selection Guide **▼** P.10

etc

アイテム一覧 Part Numbers

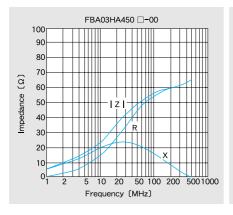
特性図 Electrical Characteristics

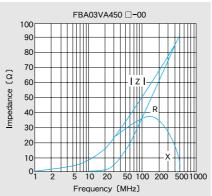
梱包 Packaging P.330 信頼性 Reliability Data

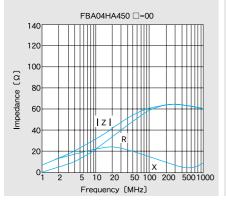
使用上の注意 Precautions P.356 I

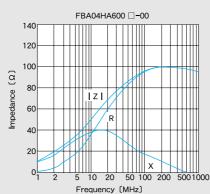
インピダース周波数特性 -

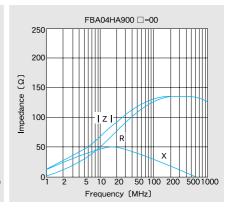
IMPEDANCE-vs-FREQUENCY CHARACTERISTICS

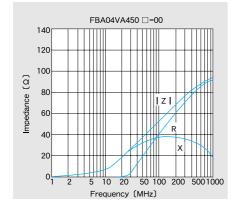


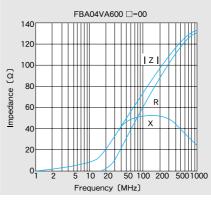


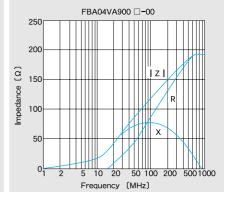


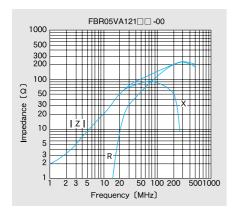


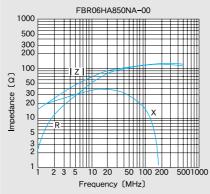


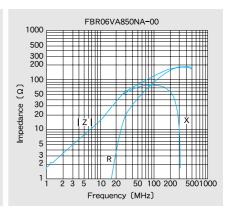


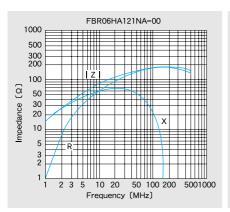


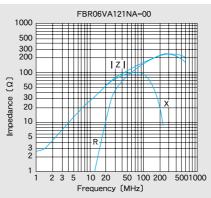


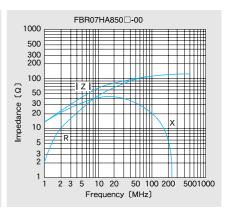


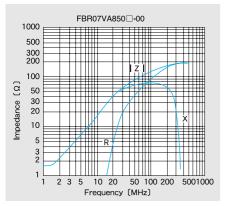


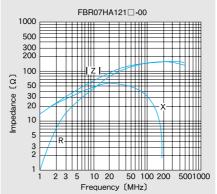


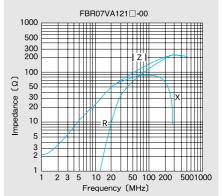












Measured by HP4191A

梱包 PACKAGING

①最小受注単位数 Minimum Quantity

アキシャルリード Axial lead(FBA)

	リード加工	標準数量:	Standard quantity (pcs)
Type	形状記号	袋詰め	テーピング Taped
,,	Lead configration	Bulk	つづら折りAmmo
	NA	1000	
	AB, BB		2000
FBA03	KE,KF	500	
I BA03	KD	1000	
	US	1000	
	UB		3000
	NA, KD, US	1000	
FBA04	KE, KF, VS	500	
I DAO4	AB, BB		1000
	VB, UB		3000

ラジアルリード Radial lead(FBR)

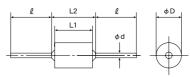
リード加工	標準数量:	Standard quantity (pcs)					
形状記号	袋詰め	テーピング Taped					
Lead configuration	Bulk	つづら折りAmmo					
NA	1000						
SA		2000					
NA	1000						
NB	1000						
SB		2000					
	形状記号 Lead configuration NA SA NA NB	形状記号					

 $\mathsf{Unit} \ \mathbf{:} \ \mathsf{mm}(\mathsf{inch})$

②単品寸法 Bulk dimensions

アキシャルリード Axial lead(FBA)

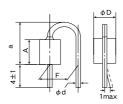
NA形状



Type	寸法 Dimensions (mm) (inch)									
1,700	φD	L1	L2	φd	l					
FBA03□450	2.5±0.2	4.5±0.3	6.5max.							
	(0.098±0.008)	(0.177±0.012)	(0.256max.)							
FBA04□450	3.5±0.2	4.5±0.3	6.5max.							
	(0.138±0.008)	(0.177±0.012)	(0.335max.)	0.65±0.05	18min.					
FBA04□600	3.5±0.2	$6.0^{+0.5}_{-0}$	8.5max.	(0.026±0.002)	(0.709min.)					
	(0.138±0.008)	$(0.236^{+0.020}_{-0})$	(0.335max.)							
FBA04□900	3.5±0.2	9.0±0.5	11.0max.							
	(0.138±0.008)	(0.354±0.020)	(0.433max.)							

Unit: mm(inch)

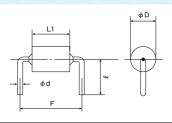
US形状



Type	寸法 Dimensions (mm) (inch)							
.,,,,	φD	Α	а	F	φd			
FBA03□450	2.5±0.2	4.5±0.3	9.0max.					
	(0.098±0.008)	(0.177±0.012)	(0.354max.)	5±1	0.65±0.05			
FBA04□450	3.5±0.2	4.5±0.3	9.0max.	(0.197±0.039)	(0.026±0.002)			
	(0.138±0.008)	(0.177±0.012)	(0.354max.)					

Unit: mm(inch)

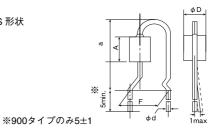
KD/KE/KF 形状



Type	リード 加工形状 記 号	寸法 Dimensions (mm) (inch)					
.,,,,	LEAD SYMBOL	φD	F	L1	φd	l	
FBA03□450		2.5±0.2	10.0±1.0	4.5±0.3		7±2	
		(0.098±0.008)	(0.394±0.040)	(0.177±0.012)		(0.276±0.079)	
FBA04□450	KD	3.5±0.2	10.0±1.0	4.5±0.3	0.65±0.05	7.5±2	
	ND	(0.138±0.008)	(0.394±0.040)	(0.177±0.012)	(0.026±0.020)	(0.295±0.079)	
FBA04□600		3.5±0.2	10.0±1.0	6.0 +0.5		7.5±2	
		(0.138±0.008)	(0.394±0.040)	$(0.236^{+0.020}_{-0})$		(0.295±0.079)	
FBA03□450		2.5±0.2	12.5±1.0	4.5±0.3		7±2	
		(0.098±0.008)	(0.492±0.004)	(0.177±0.012)		(0.276±0.079)	
FBA04□450		3.5±0.2	12.5±1.0	4.5±0.3		7.5±2	
	KE	(0.138±0.008)	(0.492±0.004)	(0.177±0.012)	0.65±0.05	(0.295±0.079)	
FBA04□600	NE.	3.5±0.2	12.5±1.0	6.0 +0.5	(0.026±0.020)	7.5±2	
		(0.138±0.008)	(0.492±0.004)	$(0.236^{+0.020}_{-0})$		(0.295±0.079)	
FBA04□900		3.5±0.2	12.5±1.0	9.0±0.5		7.5±2	
		(0.138±0.008)	(0.492±0.004)	(0.354±0.020)		(0.295±0.079)	
FBA03□450		2.5±0.2	15.0±1.0	4.5±0.3		7±2	
		(0.098±0.008)	(0.591±0.004)	(0.177±0.012)		(0.276±0.079)	
FBA04□450		3.5±0.2	15.0±1.0	4.5±0.3		7.5±2	
	KF	(0.138±0.008)	(0.591±0.004)	(0.177±0.012)	0.65±0.05	(0.295±0.079)	
FBA04□600	N.F	3.5±0.2	15.0±1.0	6.0 +0.5	(0.026±0.020)	7.5±2	
		(0.138±0.008)	(0.591±0.004)	(0.236 +0.020)		(0.295±0.079)	
FBA04□900		3.5±0.2	15.0±1.0	9.0±0.5		7.5±2	
		(0.138±0.008)	(0.591±0.004)	(0.354±0.020)		(0.295±0.079)	
					Unit	: mm(inch)	

 $\mathsf{Unit} \ \mathbf{:} \ \mathsf{mm}(\mathsf{inch})$

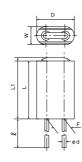
VS 形状



Type	寸法 Dimensions(mm)(inch)								
1,700	φD	А	а	F	φd				
FBA04□450	3.5±0.2	4.5±0.3	12.5max.	5±1	0.65±0.05				
	(0.138±0.008)	(0.177±0.012)	(0.492max.)	(0.197±0.039)	(0.026±0.002)				
FBA04□600	3.5±0.2	6.0 +0.5	12.5max.	5±1	0.65±0.05				
	(0.138±0.008)	$(0.236^{+0.020}_{-0})$	(0.492max.)	(0.197±0.039)	(0.026±0.002)				
FBA04□900	3.5±0.2	9.0±0.5	16.0max.	5±1	0.65±0.05				
	(0.138±0.008)	(0.354±0.020)	(0.630max.)	(0.197±0.039)	(0.026±0.002)				

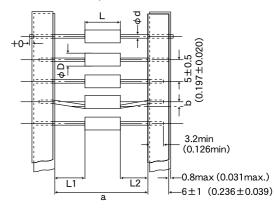
ラジアルリード Radial lead(FBR)

NA形状



Type	寸法 Dimensions (mm) (inch)							
1,400	D	L	L1	φd	l			
FBR05VA121	5.0max.	7.5	9.0max.	0.65±0.05	10 +3			
	(0.197max.)	(0.295)	(0.354max.)	(0.026±0.002)	$(0.394^{+0.118}_{-0.197})$			
FBR06□850	6±0.5	5.0	7.0max.	0.65±0.05	10 +3			
	(0.236±0.020)	(0.197)	(0.276max.)	(0.026±0.002)	$(0.394^{+0.118}_{-0.197})$			
FBR06□121	6±0.5	7.0	9.0max.	0.65±0.05	10 +3			
	(0.236±0.020)	(0.276)	(0.354max.)	(0.026±0.002)	$(0.394^{+0.118}_{-0.197})$			
	W	F						
FBR05VA121	2.5max.	2.5±1						
	(0.098max.)	(0.098±0.039)						
FBR06□850	3.0±0.5	2.5±1						
	(0.118±0.020)	(0.098±0.039)						
FBR06□121	3.0±0.5	2.5±1						
	(0.118±0.020) (0.098±0.039) Unit: mm(inch)							

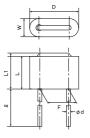
③テーピング寸法 Taping Dimensions AB (a: 26mm) 形状 (1.02inch lead space)



Туре		最 小 挿入ピッチ Minimum					
	D	L	а	b	IL ₁ -L ₂ I	φd	insertion pitch
FBA03	2.5±0.2 (0.098±0.008)	4.5±0.3 (0.177±0.012)	26 ^{+1.5} ₋₀ (1.02 ^{+0.059} ₋₀)	1.0max (0.039max)		O.65±0.05 (0.026±0.002)	10.0 (0.394)
FBA04	3.5±0.2 (0.138±0.008)	4.5±0.3 (0.177±0.012)	26 ^{+1.5} ₋₀ (1.02 ^{+0.059} ₋₀)	1.0max (0.039max)		0.65±0.05 (0.026±0.002)	10.0 (0.394)

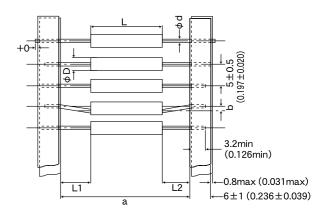
Unit: mm(inch)

NB形状



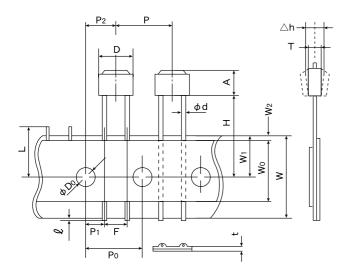
Type	寸法 Dime	寸法 Dimensions (mm) (inch)							
1,700	D	L	L1	φd	l				
FBR07□850	7.5±0.5	5.5	7.0max	0.6±0.05	5+1				
	(0.295±0.020)	(0.217)	(0.276max.)	(0.024±0.002)	$(0.197^{+0.039}_{-0.079})$				
FBR07□121	7.5±0.5	7.5	9.0max.	0.6±0.05	5 +1				
	(0.295±0.020)	(0.295)	(0.354max.)	(0.024±0.002)	$(0.197^{+0.039}_{-0.079})$				
	w	F							
FBR07□850	2.5max.	5 ⁺¹ 0.5							
	(0.098max.)	$(0.197^{+0.039}_{-0.020})$							
FBR07□121	2.5max. 5 ⁺¹ _{-0.5}								
	$(0.098 \text{max.}) (0.197^{+0.039}_{-0.020})$		Unit :	mm(inch)					

B□ (a:52mm) 形状 (2.05 inches lead space)

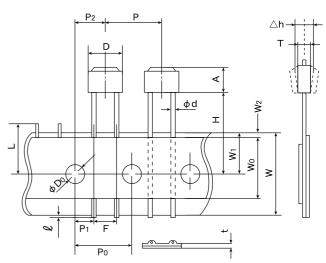


Type		寸 法 Dimensions							
Туре	D	L	а	b	IL ₁ -L ₂ I	φd	Minimum insertion pitch		
FBA03	2.5±0.2 (0.098±0.008)	4.5±0.3 (0.177±0.012)	52 ⁺² -1 (2.05 ^{+0.079} _{-0.039})	1.2max (0.047max)		O.65±0.05 (0.026±0.002)	10.0 (0.394)		
FBA04	3.5±0.2 (0.138±0.008)	4.5±0.3 (0.177±0.012)	52 ⁺² -1 (2.05 ^{+0.079} _{-0.039})	1.2max (0.047max)		0.65±0.05 (0.026±0.002)	10.0 (0.394)		

SA (F : 2.5mm pitch) 形状 (0.098 inches)



SB (F:5mm pitch) 形状 (0.197 inches)



寸 法	記号	寸法	記号	寸法
Туре	Symbol	Dimensions	Symbol	Dimensions
	A		w	18 +1.0
		121:9.0max.		$(0.709^{+0.039}_{-0.020}\)$
		(0.354max)	Wo	12.5min.
				(0.492min.)
	Т	2.5max.	W ₁	9 +0.75 -0.5
		(0.098max.)		$(0.354 {}^{+0.039}_{-0.020})$
	D	5.0max.	W2	3max.**2
		(0.197max.)		(0.118max.)
	Н	$18.0_{-0}^{+2.0}$	l	1.0max.
		$(0.709^{+0.079}_{-0})$		(0.039max.)
FBR05	Р	12.7±1.0	φDo	4±0.3
		(0.500 ± 0.039)		(0.157±0.012)
	Po	12.7±0.3 *1	φd	0.65 ± 0.05
		(0.500 ± 0.039)		(0.026 ± 0.002)
	P ₁	5.1±0.7	L	11.0max.
		(0.201 ± 0.028)		(0.433max.)
	P ₂	6.35±1.3	t	0.7±0.2
		(0.250 ± 0.051)		(0.028 ± 0.008)
	F	2.5 +1.0 -0.5		
		$(0.098 \ ^{+0.039}_{-0.020})$		
	△h	0±2		
		(0±0.079)		Unit: mm(inch)

寸 法	記号	寸法	記号	寸法
Туре	Symbol	Dimensions	Symbol	Dimensions
	Α	121:9.0max.	w	18 +1.0
		(0.354max.)		$(0.709^{+0.039}_{-0.020})$
		850:7.0max.	Wo	12.5min.
		(0.276max.)		(0.492min.)
	Т	2.5max.	W ₁	$9^{+0.75}_{-0.5}$
		(0.098max.)		$(0.354 \ ^{+0.039}_{-0.020} \)$
	D	7.5±0.5	W ₂	3max. *2
		(0.925±0.020)		(0.118max.)
	Н	18.0 +2.0	l	1.0max.
		$(0.709^{+0.079}_{-0})$		(0.039max.)
FBR07	Р	12.7±1.0	φD0	4±0.3
		(0.500 ± 0.039)		(0.157±0.012)
	Po	12.7±0.3 **1	ød	0.6 ± 0.05
		(0.500 ± 0.012)		(0.024 ± 0.002)
	P ₁	3.85±0.8	L	11.0max.
		(0.152±0.028)		(0.433max.)
	P ₂	6.35±1.3	t	0.7±0.2
		(0.250 ± 0.051)		(0.028 ± 0.008)
	F	5 ^{+1.0} _{-0.5}		
		$(0.197 \ ^{+0.039}_{-0.020})$		
	△h	0±2		
		(0 ± 0.079)		Unit: mm(inch)

^{※1 20}ピッチにつき、累積誤差±2mm以内。

^{※2} 貼付テープは、台紙よりはみ出さないこと。

^{*1} Accumulated error for 20 pitches is ±2mm.

 $[\]ensuremath{\%2}$ Bonding tape must not protrude from the base tape.

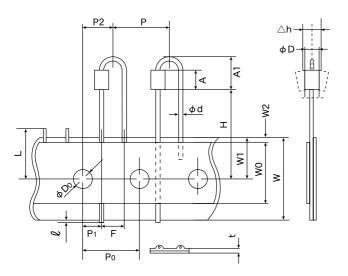
^{※1 20}ピッチにつき、累積誤差±2mm以内。

^{※2} 貼付テープは、台紙よりはみ出さないこと。

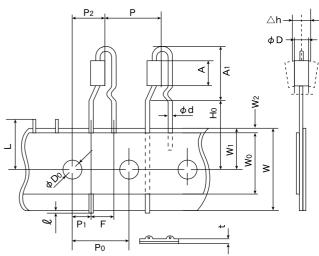
[%]1 Accumulated error for 20 pitches is ± 2 mm.

 $[\]ensuremath{\ensuremath{\%}}\xspace^{\ensuremath{\ensuremath{\%}}\xspace^{\ensuremath{\ens$

UB 形状







寸 法	記号	寸法	記号	寸法
Туре	Symbol	Dimensions	Symbol	Dimensions
	Α	4.5±0.3	△h	0±2
		(0.177±0.012)		(0 ± 0.079)
	A1	9.0max.	w	18 +1.0
		(0.354max.)		$(0.709^{+0.039}_{-0.020})$
	φD	03: 2.7max.	Wo	12.5min.
		(0.106max.)		(0.492min.)
		04:3.7max.	W1	9 +0.75
		(0.146max.)		$(0.354^{+0.039}_{-0.020}\)$
	Н	20.0 +0.5	W2	3.0max.**2
FBA03□450		$(0.787^{+0.020}_{-0.039})$		(0.118max.)
FBA04□450	P	12.7±0.1	l	1.0max.
		(0.500±0.039)		(0.039max.)
	P0	12.7±0.3 **1	φD0	4.0±0.3
		(0.500±0.012)		(0.157±0.012)
	P1	3.85±0.8	φd	0.65±0.05
		(0.152±0.032)		(0.026 ± 0.002)
	P2	6.35±1.3	L	11.0max.
		(0.250±0.051)		(0.433max.)
	F	5.0±1.0	t	0.7±0.2
		(0.197±0.039)		(0.028±0.008)

^{※1 20}ピッチにつき、累積誤差±2mm以内。

寸 法	記号	寸法	記号	寸法
Type	Symbol	Dimensions	Symbol	Dimensions
	Α	450: 4.5±0.3	F	5.0±1.0
		(0.177±0.012)		(0.197±0.039)
		600: 6.0 ^{+0.5}	△h	0±2
		$(0.236^{+0.020}_{-0})$		(0 ± 0.079)
		900: 9.0±0.5	W	18 +1.0 -0.5
		(0.354±0.020)		$(0.709{}^{+0.039}_{-0.020})$
	A1	⁴⁵⁰ _{600:} 12.5max.	Wo	12.5min.
		(0.492max.)		(0.492min.)
		900: 16.0max.	W1	9 +0.75
FBA04□450		(0.630max.)		$(0.354^{+0.039}_{-0.020})$
FBA04□600	φD	3.7max.	W2	3.0max.**2
FBA04□900	·	(0.146max.)		(0.118max.)
	Ho	16.0±0.5	l	1.0max.
		(0.650±0.020)		(0.039max.)
	Р	12.7±1.0	φD0	4.0±0.3
		(0.500±0.039)		(0.157 ± 0.012)
	P0	12.7±0.3 **1	ød	0.65±0.05
		(0.500±0.012)		(0.026 ± 0.002)
	P1	3.85±0.8	L	11.0max.
		(0.152±0.032)		(0.433max.)
	P2	6.35±1.3	t	0.7±0.2
		(0.250±0.051)		(0.028 ± 0.008)

^{※1 20}ピッチにつき、累積誤差±2mm以内。

333

Unit: mm(inch)

^{※2} 貼付テープは、台紙よりはみ出さないこと。

^{%1} Accumulated error for 20 pitches is $\pm 2\text{mm}.$

 $[\]frak{2}$ Bonding tape must not protrude from the base tape.

^{※2} 貼付テープは、台紙よりはみ出さないこと。

^{※1} Accumulated error for 20 pitches is ±2mm.

 $[\]frak{2}$ Bonding tape must not protrude from the base tape.

				Specifie	ed Value				
Item	LA02 Type/ LA03 Type	LA04 Type	LA05 Type	LHL	FBA/FBR	LAV35	FL05 Type	FL06BT Type	Test Method and Remarks
1.Operating temperature Range	−25~+105°C				−25~+85°C	−25~+105℃			LA · FL: Including self-generated heat LHL□□□: Including self-generated heat [LHL□□□]
2.Storage temperature	-40~+85°C								
Range 3.Rated current	Within the sp	pecified toleran	nce						LA: The maximum DC value having inductance within 10% and temperature incease within 20°C by the application of DC bias. LHL LAV35: The maximum DC value having inductance decrease within 10% and temperature incease within the following specified temperature by the application of DC bias. Reference temperature: 20°C(LHL06, LAV35): 25°C(LHL08, LHL10, LHL13): 30°C(LHLC06, LHL206, LHL16, LHLP) FB: No disconnection or appearance abnormality by continuous current application for 30 min. Chage after the application shall be within ±20% of the initial value. This is not guaranteed for electrial characteristics during current application.
									FL: The maximum DC value having temperature rise within specified value.
4.Impedance					Within the specified tolerance			Refer to individual specification	FB: Measuring equipment: Impedance analyzer (HP4191A)or its equivalent Measuring frequency: Specified frequency FL06BT: Measuring equipment: 4291A (HP) or its equivalent Measuring frequency: Specified frequency
5. Inductance	Within the sp	pecified tolerar	nce			Within the spance	ecified toler-		LA: Measuring equipment: LCR meter(HP4285A + HP42851A or its equivalent) Measuring frequency: Specified frequency LHL : Measuring equipment: Q meter(HP4285A+HP42851A or its equivalent) LCR meter(HP4262A) or its equivalent(at 1KHz) Measuring frequency: Specified frequency LAV35: Measuring equipment: Q meter(HP4285A+HP42851A or its equivalent) Measuring frequency: Specified frequency FLOSR: Measuring frequency: Specified frequency

				Specifie	ed Value				
Item	LA02 Type/ LA03 Type	LA04 Type	LA05 Type	LHL	FBA/FBR	LAV35	FL05 Type	FL06BT Type	Test Method and Remarks
6.Q	Within the sp	pecified tolerar	ссе			Within the specified tolerance			LA: Measuring equipment: LCR meter(HP4285A+HP42851A or its equivalent) Measuring frequency: Specified frequency LHL \(\subseteq \text{LAV35} \) \(\text{LAV35} \) \(\text{except LHLP} \) : Measuring equipment: \(\text{Q meter(HP4285A+HP42851A or its equivalent} \) \(\text{Q meter(HP4342A) or its equivalent} \) \(\text{Measuring frequency} \) : Specified frequency
7.DC Resisitance	Within the sp	pecified tolerar	ice			LA: Measuring equipment: low ohmmeter (A&D AD5812 or its equivalent) LHL - FB · LAV35 · FL: Measuring equipment: DC ohmmetr			
8.Self resonance frequency	Within the sp	oecified tolerar	nce			Within the specified tolerance			LA: Measuring equipment: Network analyzer(Anritsu MS620J or its equivalent) LHL \(\subseteq \cdot \text{LAV35}(\text{except LHLP}): \) Measuring equipment: (HP4191A, 4192A) its equivalent
9.Temperature characteristic	△L/L: Withi	in±5%		△L/L: Within±7%		△L/L: Within±5%			LA: Change of maximum inductance deviation in step 1to5 Step

_					ed Value	1						
Item	LA02 Type/ LA03 Type	LA04 Type	LA05 Type	LHL	FBA/FBR	LAV35	FL05 Type	FL06BT Type	Test	Method and	d Remarks	
10.Terminal strength:	No abnorma	lity such as cu	t lead, or loose	eness.	No abnor-	No abnormal	ity such as cut		LA:			
tensile force					mality such	lead,or loose	eness.		Apply the stated tens	sile force pro	gressively in	the direction
					as cut lead,				to draw terminal.		_	
					or loose-				force(N) d	uration(S)		
					ness.				25	5		
									LHL□□□·LAV:			
									Apply the stated tens	sile force pro	gressively in	the direction
									to draw terminal.			
									Nominal wire diameter tensile	force (N)	uration(S)	
									φd(mm)			
									0.3<ød≦0.5 0.5<ød≦0.8	10	30±5	
									0.5<φd≦0.8 0.8<φd≦1.2	25	30±3	
									FBA:	20		
									A bead shall be fixed	and static lo	aded 20±1N	J(2.0±0.1 kaf)
									in axial direction of le			
									FL05R□:			
									Fix the component i	n the direct	tion to draw	terminal,and
									gradually apply the to	ensile force	of 4.9 N.	
11.Over current				There shall					LHL:			
				be no scorch					Measuring current:	Rated curre	ent×2	
				or short of					Duration: 5min.			
				wire.					Number of measurin	g: one time	9	
12.Terminal strength:	No abnorma	llity such as cu	it lead, or loos	eness.					LA:			
bending									Suspend a mass at t though angel of 90 a			
									eration is done over a			
									in the opposite direct			occona pona
									Number of bends: T			
									Nominal wire	Bending	Mass	reference
									diameter tensile ϕ d(mm)	force (N)	W	eight (kg)
									0.3<¢d≦0.5	2.5		0.25
									0.5<¢d≦0.8	5		0.50
									LH·FB·LAV:			
									Suspend a mass at t			
									though angel of 90 a			
									eration is done over a			secona bena
									in the opposite direct		maue.	
									Nominal wire	Bending	Mass	reference
									diameter tensile ϕ d(mm)	force (N)		eight (kg)
									0.3<¢d≦0.5	2.5		0.25
									0.5<¢d≦0.8	5		0.5
									0.8<¢d≦1.2	10		1.0
			I									
13.Insulation resisitance:				100M Ω min.					LHL : Applied voltage : 500	0 VDC		
between the terminals									Duration: 60 sec.	O VDC		
and body 14.Insulation resistance:					1MΩmin.	-			FBA · FBR:			
between terminals and					(Other than				Applied voltage: 10	0 VDC		
core					materail				Duration: 60±5 sec			
					code MA)							
15.Withstanding: between				No abnor-					(LHL□□□)			
the terminals and body				mality such					Accoding to JIS C51		C)	
				as insula-					Metal global metho			
				tion dam-					Applied voltage			
			I	age					Duration: 60 se	U.		

				Specific					
ltem	LA02 Type/ LA03 Type	LA04 Type	LA05 Type	LHL	FBA/FBR	LAV35	FL05 Type	FL06BT Type	Test Method and Remarks
16.DC bias characteristic	△L/L: With	in —10%				△L/L: −10% Within			LA · LAV35 : Measure inductance with appliation of rated current using LCR meter to compare it with the initial value.
17.Body strength	No abnorma	ality as damag	Э.		No signifi- cant dam- age such as cracks on body.	No abnormality as damage.			LA02 · LAV35 : Applied force : 30N Duration : 10 sec. Speed : Shall attain to specified force in 2 sec. LA03 · LA04 · LA05 : Applied force : 50N Duration : 10 sec. Speed : Shall attain to specified force in 2 sec. FB : Applied force : 50±3N Duration : 30±1 sec. Press Pressing jig Specimen
18.Resisitance to vibration	△L/L: Within±5% Q:30min.	△L/L: Within±5% △Q/Q: Within±10%	△L/L: Within±5% Q:15min.	Appearance: No abnomality △L/L: Within±5% Q change: Within±30% (LHLP: only △L/L)	Appearance: No abnomality Impedance change: Within±20%	△L/L∶ Within±5% Q∶30min.			LA: Accoding to JIS C5102 8. 2 Vibaration type: A Directions: 2 hrs each in X, Y and Z directions total: 6hrs. Frequency range: 10 to 55 to 10Hz(1min.) Amplitude: 1.5mm Mounting method: Soldering onto printed board. Recovery: At least 1hr of recovery under the standard condition after the test, followed by the measurement within 2hrs. LHL

				Specifie	ed Value				
Item	LA02 Type/ LA03 Type	LA04 Type	LA05 Type	LHL	FBA/FBR	LAV35	FL05 Type	FL06BT Type	Test Method and Remarks
19.Resistance to shock	No significan	t abnormality ir	appearance			No signifi-			LA·LAV35:
						cant abnor-			Drop test
						mality in ap-			Impact material: concrete or vinyl tile
						pearance			Height: 1m
									Total number of drops: 10 times
20.Solderability	At least 759	% of terminal	electrode is	At least	At least	At least 75%	6 of lead circ	u, ference is	LA:
	coverd by n	new solder.		75% of lead	90% of lead	covered by	new solder.		Solder temperature : 230±5°C
				circu,	circu,				Duration: 2±0.5 sec.
				ference is	ference is				
				covered by	covered by				LHL□□□:
				new solder.	new solder.				Solder temperature : 235±5℃
									Duration: 2±0.5 sec.
									Immersion depth: Up to 1.5mm from bottom of kinked part.
									[LHL06, LHLC06, LHLZ06]
									: Up to 1.5mm from bottom of case.
									[LHL08, LHL10, LHL13, LHL16]
									FB:
									Solder temperature : 230±5℃
									Duration : 3±1 sec.
									Immersion depth: Up to 1.5mm from terminal root.
									LAV35:
									Solder temperature : 230±5℃
									Duration: 2±0.5 sec.
									FL05R□:
									Solder temperature: 230±5°C
									Duration: 2±0.5 sec.
									Immersion depth: Up to 2~2.5mm from terminal root.
									FL06BT:
									Solder temperature : 230±5°C
									Duration: 3±1 sec.
									Immersion depth: Up to 0.5~1.0mm from terminal root.

Item	LA02 Type/ LA03 Type	LA04 Type	LA05 Type	LHL	FBA/FBR	LAV35	FL05 Type	FL06BT Type	Test Method and Remarks
21.Resisitance to soldering heat		t abnormality	△L/L∶ Within ±5% Q∶15min.	No significant abnormality in appearance Inductance change: Within±5% Q change: Within±30% (LHLP: only △L/L)	No significant abnormality in appearance Impedance change: Within±20%	△L/L∶ Within±5% Q∶30min.	Refer to individual specification	No significant abnormality in appearance Impedance change: Within±20%	LA: Solder temperature: 260±5°C(LA02) 270±5°C(LA03 · LA04 · LA05) Duration: 5±0.5 sec. One time Immersed conditions: Inserted into substrate with t = 1.6mm Recovery: At least 1hr of recovery under the standard condition after the test, followed by the measurement within 2hrs. LHL□□□: Solder bath method Solder temperature: 260±5°C Duration: 10±1 sec. : Up to 1.5mm from bottom of kinked part. [LHL06, LHLC06, LHLZ06] : Up to 1.5mm from bottom of case. [LHL08, LHL10, LHL13, LHL16, LHLP□□] Manual soldering Solder temperature: 350±10°C(At the tip of soldering iron) Duration: 5±1 sec. : Up to 1.5mm from bottom of kinked part. [LHL06, LHLC06, LHLZ06] : Up to 1.5mm from bottom of case. [LHL08, LHL10, LHL13, LHL16, LHLP□□] Caution: No excessive pressing shall be applied to terminald Recovery: 4 to 24hrs of recovery under the standard condition after the tset. FB: Solder bath method Condition 1 Solder temperature: 260±5°C Duration: 10±1 sec. Immersion depth: Up to 1.5mm from terminal root. Condition 2 Solder temperature: 350±5°C Duration: 3±1 sec. Immersion depth: Up to 1.5mm from terminal root. Recovery: 3hrs of recovery under the standard condition after the test. LAV35: Solder temperature: 260±5°C Duration: 5±0.5 sec. Immersion depth: Up to 2.0 to 2.5mm from botoom of kinked part. Recovery: 4 to 24hrs of recovery under the standard condition after the test. LAV35: Solder condition: 260±5°C Duration: 5±0.5 sec. Immersion depth: Up to 0.5 to 1.0mm from terminal root.
									Recovery: 3hrs of recovery under the standard condition after the test.

Item LA0:	.02 Type/ .03 Type	LA04 Type	LA05 Type	LHL	FBA/FBR	LAV35	FL05 Type	FL06BT Type	Test Method and Remarks
	easa avoid	the ultrasoni	c cleaning of		No significant abnormality in appearance Impedance change:	PIease avoid the ul- trasonic cleaning of this product.			FB: Solvent temperature: 20~25°C Duration: 30±5 sec. Solvent type: Acetone, trichloroethylene Recovery: 3hrs of recovery under the standard condition after the test.
With	ithin±10% : 30min.	△L/L: Within±10% △Q/Q: Within±30%	△L/L: Within±10% Q:15min.	Appearance: No abnormality Inductance change: Within±10% Q change: Within±30% (LHLP: only △L/L)	Appearance: No abnormality Impedance change: Within±20%	△L/L: Within±10% Q:20min.	Refer to individual specification	Appearance: No abnormality Impedance change: Within±20%	LA: Conditions for 1cycle Step Temperature(°C) Duration(min) 1

				Specific	ed Value				
ltem	LA02 Type/ LA03 Type	LA04 Type	LA05 Type	LHL	FBA/FBR	LAV35	FL05 Type	FL06BT Type	Test Method and Remarks
24.Damp heat	△L/L: Within±10% Q:30min.	△L/L: Within±10% △Q/Q: Within±30%	△L/L: Within±10% Q:15min.		Appearance: No abnormality Impedance change: Within±20%	△L/L: Within±10% Q:20min.			LA·LAV35: Temperature: 40±2°C Humidity: 90~95%RH Duration: 1000 hrs Recovery: At least 1hr of recovery under the standard removal from test chamber, followed by the measurement within 2hrs. FB: Temperature: 60±2°C Humidity: 90~95%RH Duration: 1000 hrs Recovery: 1 to 2hrs of recovery under the standard condition after the removal from the test cfamber.
25.Loading under damp heat	△L/L: Within±10% Q:30min.	△L/L: Within±10% △Q/Q: Within±30%	△L/L: Within±10% Q:15min.	Appearance: No abnormality Imductance change: Within±10% Q change: Within±30% (LHLP: only △L/L)		△L/L: Within±10% Q:20min.	Refer to individual specification	Appearance: No abnormality Impedance change: Within±20%	LA·LAV35: Temperature: 40±2°C Humidity: 90~95%RH Duration: 1000 hrs Applied current: Rated current Recovery: At least 1hr of recovery under the standard removal from test chamber, followed by the measurement within 2hrs. LHL□□□: Temperature: 40±2°C Humidity: 90~95%RH Duration: 1000±24 hrs Applied current: Rated current Recovery: 1 to 2hrs of recovery under the standard condition after the removal from the test cfamber. FL: Temperature: 60±3°C Humidity: 90~95%RH Duration: 500 (+12, -0)hrs Applied current: Rated current Recovery: 1 to 2hrs of recovery under the standard condition after the removal from the test cfamber.
26.Loading at high tempera- ture	△L/L: Within±10% Q:30min.	△L/L: Within±10% △Q/Q: Within±30%	△L/L: Within±10% Q:15min.			△L/L∶ Within±10% Q∶20min.			LA · LAV35: Temperature: 85±2°C Duration: 1000 hrs Applied current: Rated current Recovery: At least 1hr of recovery under the standard removal from test chamber, followed by the measurement within 2hrs.

	Specified Value								
Item	LA02 Type/ LA03 Type	LA04 Type	LA05 Type	LHL	FBA/FBR	LAV35	FL05 Type	FL06BT Type	Test Method and Remarks
27.Low temperature life test	△L/L:	△L/L:	△L/L:	Appearance:		△L/L∶	Refer to	Appearance:	LA:
	Within±10%	Within±10%	Within±10%	No abnor-		Within±10%	individual	No abnor-	Temperature: -25±2℃
	Q:30min.	△Q/Q:	Q:15min.	mality		Q:20min.	specifica-	mality	Duration: 1000 hrs
		Within±30%		Inductance			tion	Impedance	Recovery: At least 1hr of recovery under the standard re-
				change:				change:	moval from test chamber, followed by the mea-
				Within±10%				Within±20%	surement within 2hrs.
				Q change:					
				Within±30%					LHL:
				(LHLP:					Temperature: -40±3℃
				only △L/L)					Duration: 1000±24 hrs
									Recovery: 1 to 2hrs of recovery under the standard con-
									dition after the removal from the test cfamber.
									LAV35:
									Temperature: -40±3℃
									Duration: 1000 hrs
									Recovery: At least 1hr of recovery under the standard re-
									moval from test chamber, followed by the mea-
									surement within 2hrs.
									FL:
									Temperature: -40±3℃
									Duration: 500(+12, -0)hrs
									Recovery: 1 to 2hrs of recovery under the standard con-
									dition after the removal from the test cfamber.
28.High temperature life test				Appearance:			Refer to	Appearance:	LHL
				No abnor-			individual	No abnor-	Temperature: 105±3℃
				mality			specifica-	mality	Duration: 1000±24 hrs
				Inductance			tion	Impedance	Recovery: 1 to 2hrs of recovery under the standard con-
				change:				change:	dition after the removal from the test cfamber.
				Within±10%				Within±20%	
				Q change:					FL:
				Within±30%					Temperature: 85±3℃
									Duration: 500(+12, -0)hrs
									Recovery: 1 to 2hrs of recovery under the standard con-
									dition after the removal from the test cfamber.

LA Type, LH Type, FB Type, FL Type

Stages	Precautions	Technical considerations				
1.Circuit Design	Operating environment, 1.The products described in this specification are intended for					
	use in general electronic equipment,(office supply					
	equipment, telecommunications systems, measuring					
	equipment, and household equipment). They are not					
	intended for use in mission-critical equipment or systems					
	requiring special quality and high reliability (traffic systems,					
	safety equipment, aerospace systems, nuclear control					
	systems and medical equipment including life-support					
	systems,) where product failure might result in loss of life,					
	injury or damage. For such uses, contact TAIYO YUDEN					
	Sales Department in advance.					
2.PCB Design	Design	1.When Inductors are mounted onto a PC board, hole dimensions on the board sho				
	1.Please design insertion pitches of a base in the pitches that fitted a terminal interval.	match the lead pitch of the component, if not, it will cause breakage of the terminals cracking of terminal roots covered with resin as excess stress travels through the terminal legs.				
3.Considerations for	Adjustment of mounting machine					
automatic placement	1.Excessive impact load should not be imposed on the	When installing products, care should be taken not to apply distortion stress as it may deform the products.				
	products when mounting onto the PC boards.					
	2.Mounting and soldering conditions should be checked					
	beforehand.					
4.Soldering	Wave soldering					
	1.Please refer to the specifications in the catalog for a wave					
	soldering.					
	2.Do not immerse the entire Inductors in the flux during the					
	soldering operation.					
	Lead free soldering					
	1.When using products with lead free soldering, we request to	1.If products are used beyond the range of the recommended conditions, heat stresse may deform the products, and consequently degrade the reliability of the products.				
	use them after confirming of adhesion, temperature of					
	resistance to soldering heat, soldering etc sufficiently.					
	Recommended conditions for using a soldering iron:					
	Put the soldering iron on the land-pattern.					
	Soldering iron's temperature - Below 350 °C					
	Duration - 3 seconds or less					
	The soldering iron should not directly touch the inductor.					
5.Cleaning	Cleaning conditions					
	1.LA type, LH type	LA type, LH type				
	Please do not do cleaning by a supersonic wave.	1.If washing by supersonic waves, supersonic waves may deform products.				
6.Handling	Handling					
	1.Keep the inductors away from all magnets and magnetic	1.There is a case that a characteristic varies with magnetic influence.				
	objects.					
	Mechanical considerations					
	1.Please do not give the inductors any excessive mechanical	1.There is a case to be damaged by a mechanical shock.				
	shocks.					
	2.LH type	2.LH type				
	If inductors are dropped onto the floor or a hard surface they	There is a case to be broken by a fall.				
	should not be used.					
	Packing					
	1.Please do not give the inductors any excessive mechanical	1.There is a case that a lead route turns at by a fall or an excessive shock.				
	shocks.					
	In loading, please pay attention to handling indication					
	mentioned in a packing box (a loading direction / number of					
7.04	maximum loading / fragile item).					
7.Storage conditions	Storage					
	Storage	Under a high temperature and humidity environment, problems such as reductions and the state of the stat				
	1.To maintain the solderability of terminal electrodes and to	solderability caused by oxidation of terminal electrodes and deteriorati				
	keep the packing material in good condition, temperature	of taping/packaging materials may take place.				
	and humidity in the storage area should be controlled.					
	Recommended conditions Ambient temperature On 40°C					
	Ambient temperature 0~40℃					
	Humidity Below 70 % RH					
	The ambient temperature must be kept below 30°C. Even					
	under ideal storage conditions, solderability of products					
	electrodes may decrease as time passes. For this reason,					
	inductors should be used within one year from the time of					
	delivery.					
	In case of storage over 6 months, solderability shall be					
	checked before actual usage.					